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Vishay General Semiconductor

COMPLIANT

HALOGEN

FREE

# **Surface Mount Glass Passivated Rectifier**



**SMA (DO-214AC)** 

## **DESIGN SUPPORT TOOLS**

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PRIMARY CHARACTERISTICS							
I <sub>F(AV)</sub>	2.0 A						
V <sub>RRM</sub>	100 V, 200 V, 400 V, 600 V, 800 V, 1000 V						
I <sub>FSM</sub>	55 A						
I <sub>R</sub>	3.0 μΑ						
V <sub>F</sub> at I <sub>F</sub> = 2.0 A	0.854 V						
T <sub>J</sub> max.	150 °C						
Package	SMA (DO-214AC)						
Circuit configuration	Single						

### **FEATURES**

- Low profile package
- · Ideal for automated placement
- · Glass passivated pellet chip junction
- Low forward voltage drop
- Low leakage current
- · High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **TYPICAL APPLICATIONS**

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer and telecommunication.

### **MECHANICAL DATA**

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 and M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	SA2B	SA2D	SA2G	SA2J	SA2K	SA2M	UNIT
Device marking code		2B	2D	2G	2J	2K	2M	
Max. repetitive peak reverse voltage	$V_{RRM}$	100	200	400	600	800	1000	V
Average forward current	I <sub>F(AV)</sub>	2.0				Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	55				А		
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150				°C		

<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>J</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.911	-	V		
	$I_F = 2.0 \text{ A}$			0.954	1.1			
	$I_F = 1.0 \text{ A}$	T <sub>J</sub> = 125 °C		0.805	-			
	$I_F = 2.0 \text{ A}$			0.854	0.95			
Reverse current	Rated V <sub>R</sub>	T <sub>J</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.19	3	μΑ		
Reverse current	nateu v <sub>R</sub>	T <sub>J</sub> = 125 °C	IR (−/	28	90			
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A},$ $I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	1.5	-	μs		
Typical junction capacitance	4.0 V, 1 MHz		CJ	11	-	pF		

Notes

Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 40 ms



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THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	SYMBOL SA2B SA2D SA2G SA2J SA2K SA2M UNIT						UNIT
Typical thermal resistance	R <sub>0</sub> JA <sup>(1)</sup>			8	0			°C/W
Typical thermal resistance	R <sub>0</sub> JL (1)	$R_{\theta JL}^{(1)}$ 12						G/ VV

#### Note

<sup>(1)</sup> Thermal resistance from junction-to-ambient and from junction-to-lead, PCB mounted on 0.79" x 0.79" (20 mm x 20 mm) copper pad areas

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
SA2J-E3/61T	0.064	61T	1800	7" diameter plastic tape and reel				
SA2J-M3/61T	0.064	61T	1800	7" diameter plastic tape and reel				
SA2J-E3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel				
SA2J-M3/5AT	0.064	5AT	7500	13" diameter plastic tape and reel				

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

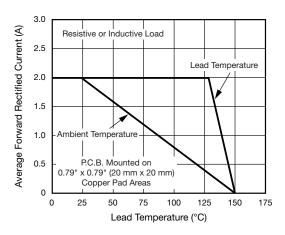


Fig. 1 - Max. Forward Current Derating Curve

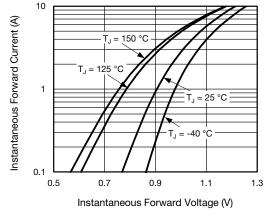


Fig. 3 - Max. Non-Repetitive Peak Forward Surge Current

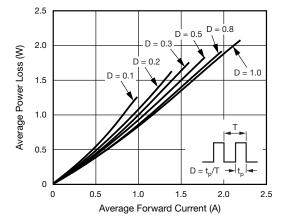


Fig. 2 - Forward Power Loss Characteristics

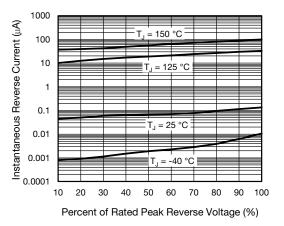


Fig. 4 - Typical Instantaneous Forward Characteristics



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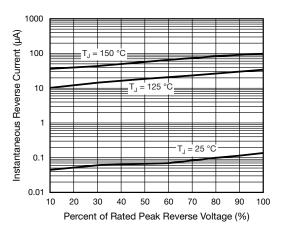


Fig. 5 - Typical Reverse Leakage Characteristics

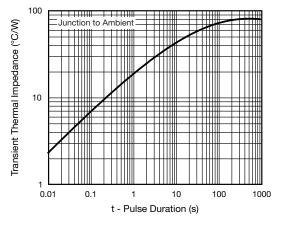


Fig. 7 - Typical Transient Thermal Impedance

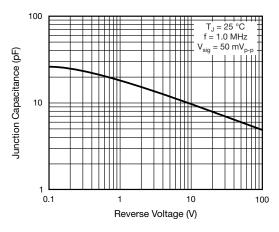
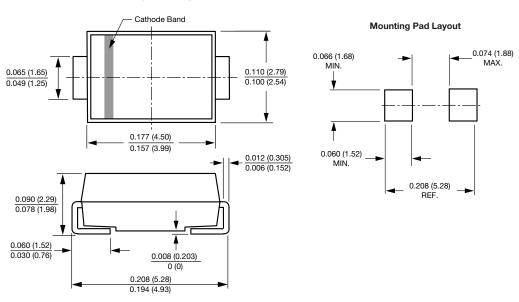


Fig. 6 - Typical Junction Capacitance

# **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

### SMA (DO-214AC)





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